

2001 International Symposium on Electrical Insulating Materials

REGISTRATION FORM

Name : Prof. / Dr. / Mr. / Mrs. / Miss _____
First Name Middle Name Last Name

Related Abstract No: _____

Affiliation: _____

Mailing Address: _____

(Street, City, State, Country, Zip Code)

Phone: _____ Fax: _____ E-mail: _____

Accompanying person: _____

First Name

Middle Name

Last Name

Type of Registration: (Please check the box.)

All payment must be made in Japanese yen.

| | |
|---------------------------------|---|
| IEEE, CES, KIEEME & IEEJ Member | <input type="checkbox"/> Japanese Yen ¥35,000 |
| Non Member | <input type="checkbox"/> Japanese Yen ¥40,000 |
| Life / Retired / Student Member | <input type="checkbox"/> Japanese Yen ¥15,000 |

※ Accompanying Person: Japanese Yen ¥5,000(includes: reception and banquet)

All attendants are requested to register by name on the Symposium Registration Form preferably by **August 31** to the Symposium Secretariat, **even if you do not prepay**. The registration made by **August 31** will be taken into account in organizing the program.

Payment for registration can be made by check (bank draft) made payable to ISEIM (Naoshi Hirai) and crossed. Please take the utmost care that the name of Naoshi Hirai clearly appears as the recipient's name on your check. In the case that the payment is done under the name of a company, or, that the payment for more than one person is done on a single check, please indicate all the necessary information (e.g. names of all members etc.) on the back of the check. In the event of cancellation, provided that written notice is received by **October 31**, a refund of **70 %** will be made. If no notice of cancellation is received, no refund can be made. If it is really inconvenient for you to pay the registration fee by **August 31**, the on-site payment can be made. Payment by credit cards or personal checks is NOT accepted.

Please mail or fax this form to:

Naoshi Hirai

Department of Electrical, Electronics, and Computer Engineering, Waseda University

3-4-1 Ohkubo, Shinjuku-ku, Tokyo 169-8555, Japan

Fax: +81-3-3204-1258

For participants living in Japan:

日本在住の方は、後ろに添付した登録用紙に記入し、現金書留にて平井宛に申し込んでください。(可能ならば **8月31日** までにお願ひします。) 発表される方は登録を必ず **8月31日** までに済ませて下さい。ただし、やむを得ない場合、当日の現金での支払いも可能です。

〒169-8555 東京都新宿区大久保 3-4-1 早稲田大学理工学部 電気電子情報工学科 平井直志

The total amount of ¥_____ is paid by check or at the Registration Desk.

Date _____, 2001

Signature _____

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REGISTRATION FORM (For Japanese)

参加申し込み(日本人用)

| | |
|-----------------|-------------------------------------|
| フリガナ 氏名 | 正員 准員 学生員 非会員 (一般・学生) |
| 勤務先 | 〒 |
| 連絡先 | Tel: () - Fax: () - e-mail: |
| Banquet 参加予定 | 参加 不参加 |
| 同封金額 | 会議参加費 ¥ _____ |
| 備考 | |

(注) 参加費： 電気学会、または IEEE の会員 ¥35,000 非会員 ¥40,000
学生 (会員、非会員を問わず) ¥15,000

テクニカルツアーの参加希望は、Hotel Reservation Form により JTB へお申し込み下さい。

送り先：〒169-8555 東京都新宿区大久保 3-4-1
早稲田大学 理工学部 電気電子情報工学科 平井直志

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